

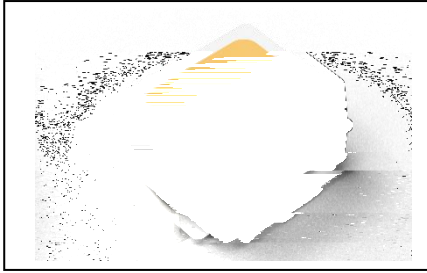


Contents 目錄



1. Description 产品介绍

1.1 General Description 产品描述



The Yellow LED, which was fabricated by using a blue chip and the phosphor.

Product Package: 2.20mmX1.40mmX1.30mm.

该产品为黄光 LED，是由蓝光芯片激发荧光粉而形成。产品尺寸：2.20mmX1.40mmX1.30mm.

1.2 Features 产品特征

PLCC Package. PLCC封装

Extremely wide viewing angle. 发光角度大

Suitable for all SMT assembly and solder process. 适用于所有的SMT组装和焊接工艺

Available on tape and reel. 适用于载带及卷轴

Moisture sensitivity level: Level 2. 防潮等级 Level2

Compliance with RoHS and REACH. 符合RoHS和REACH要求

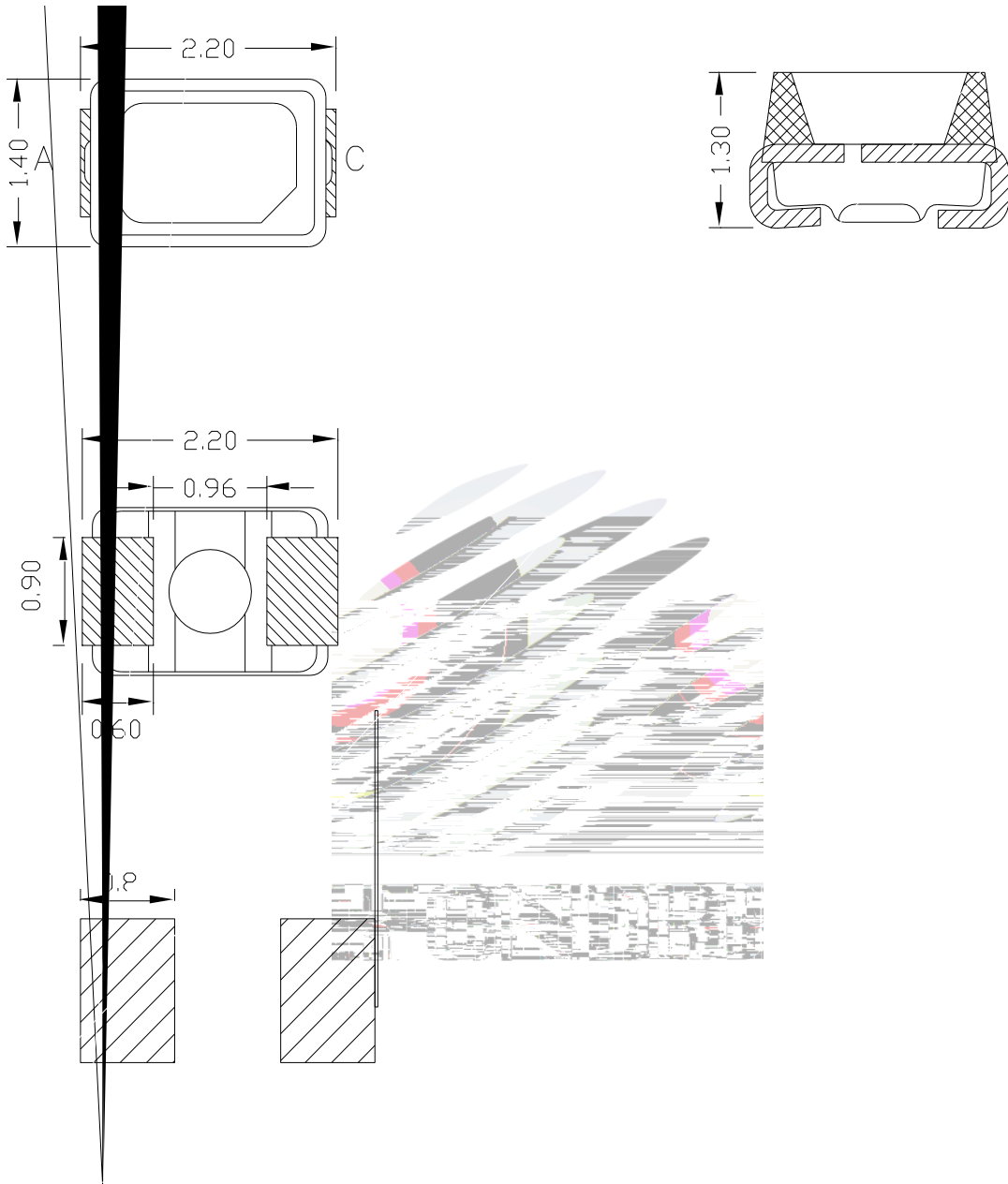
Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101 Stress Test Qualification for Automotive Grade Discrete Semiconductors 资格：产品资格测试计划基于AEC-Q101汽车级分立半导体应力测试资格准则

1.3 Application 产品应用

Automotive Lighting Interior. 汽车内饰照明



1.4 Package Dimension 封装尺寸



Notes 备注:

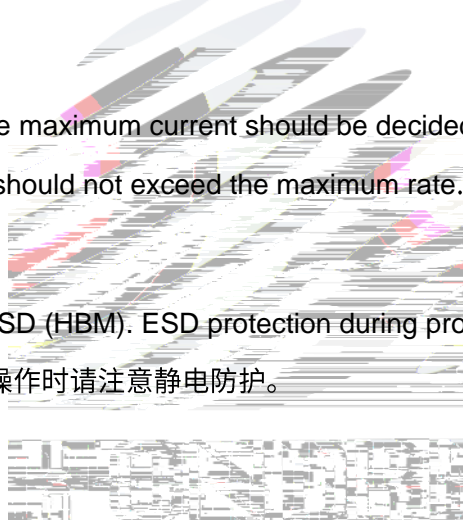
1. All dimensions units are millimeters. 所有尺寸标注单位为毫米
2. All dimensions tolerances are 0.20mm unless otherwise noted. 除特别标注外, 所有尺寸公差均为±0.20 毫米





Notes 备注:

1. 1/10 Duty cycle, 10ms pulse width. 脉宽10ms,占空比1/10.
2. The above forward voltage measurement allowance tolerance is $\pm 0.1V$. 以上所示电压测量误差 $\pm 0.1V$.
3. The above color coordinates measurement allowance tolerance is ± 0.005 . 以上所示坐标测量误差 ± 0.005 .
4. The above luminous intensity measurement allowance tolerance $\pm 10\%$. 上述发光强度的测试允许公差为 $\pm 10\%$.
5. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product. 使用功率不能超过规定的最大值。
6. All measurements were made under the standardized environment of Refond. 所有测试都是基于瑞丰现有的标准测试平台。
7. When the LEDs are in operation the maximum current should be decided after measuring the package temperature, junction temperature should not exceed the maximum rate. LED 使用的最大电流需要根据散热条件确定, 结温不能超过最大值。
8. ESD yield is over 90% at 8000V ESD (HBM). ESD protection during products handing is needed. 90%的LED通过人体模式ESD8000V测试, 在操作时请注意静电防护。



1.7 Typical Optical Characteristics Curves 典型的光學特性曲線

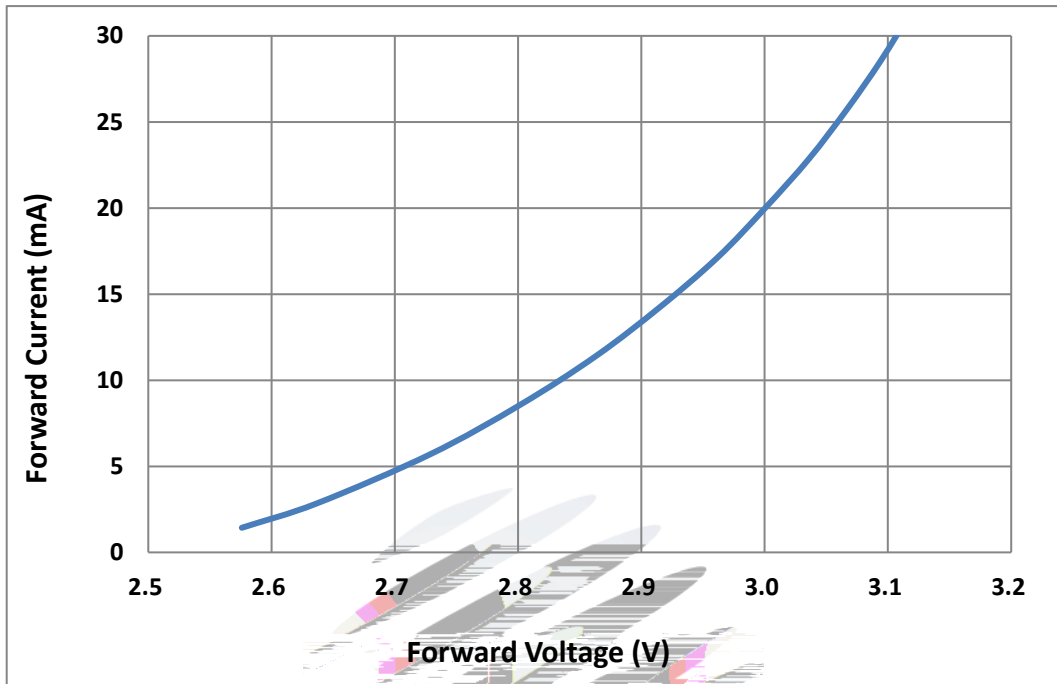


Fig. 1-7 Forward Voltage Vs Forward Current 伏安特性曲線

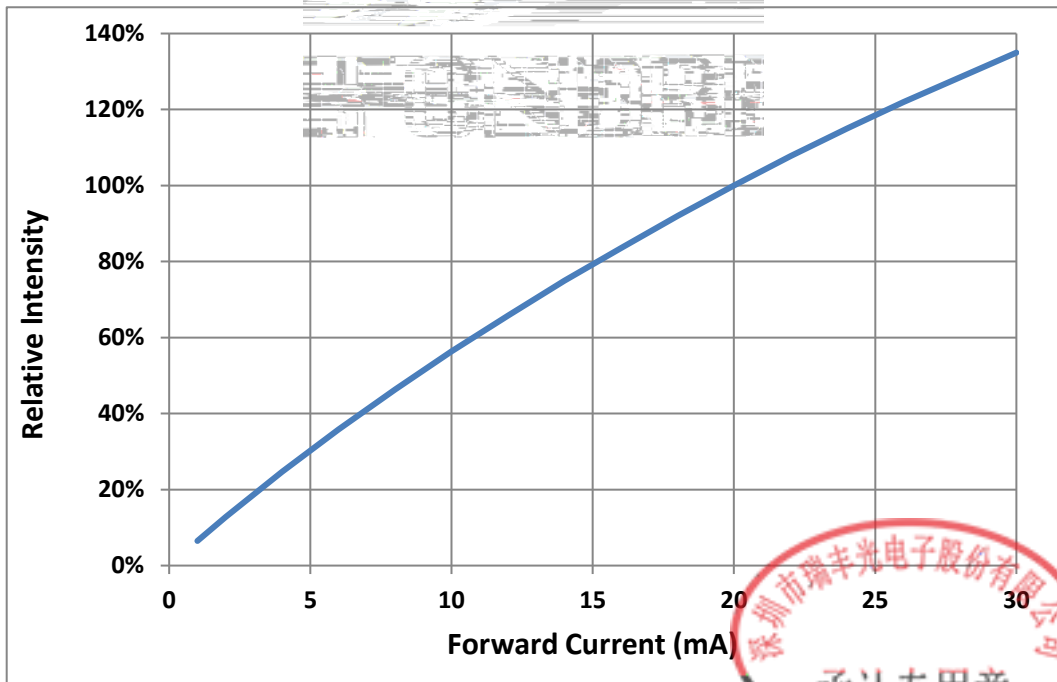
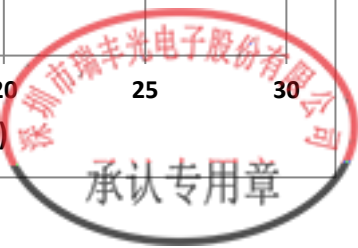


Fig. 1-8 Forward Current Vs Relative Intensity



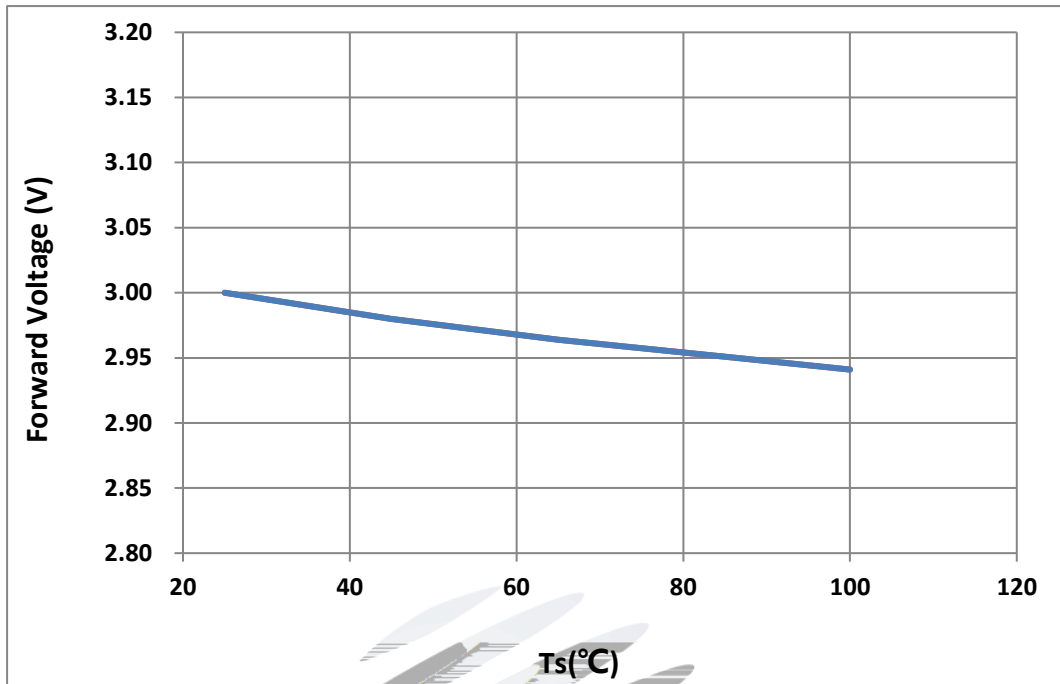


Fig. 1-11 Forward Voltage Vs Solder Temperature 电压与管脚温度特性曲线

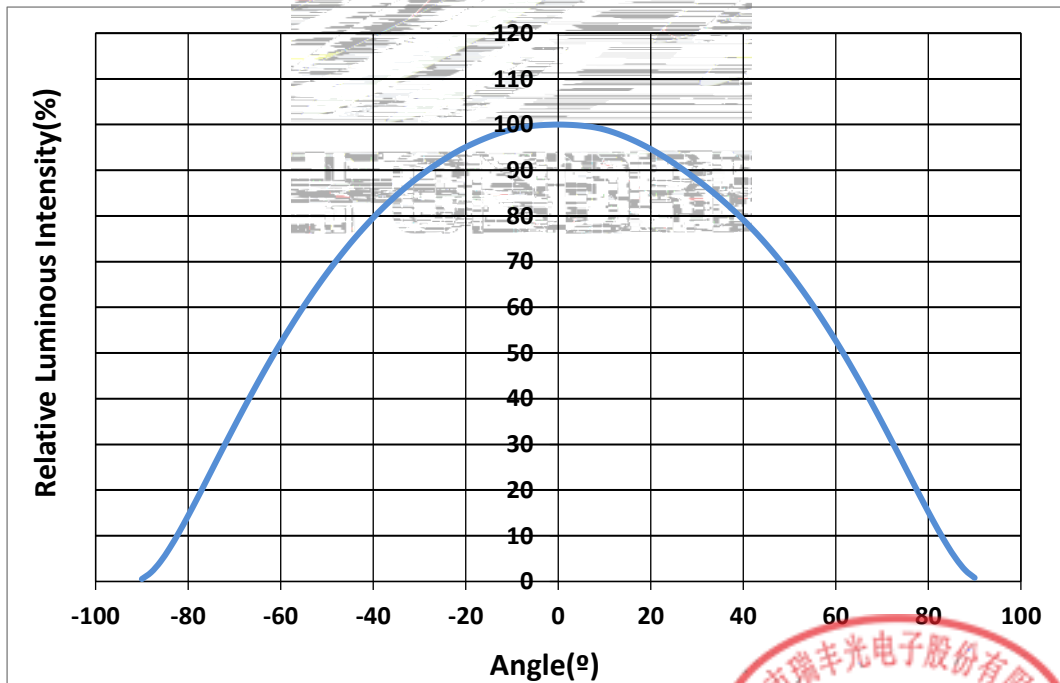
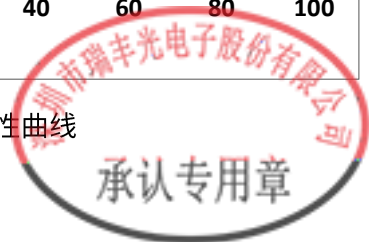
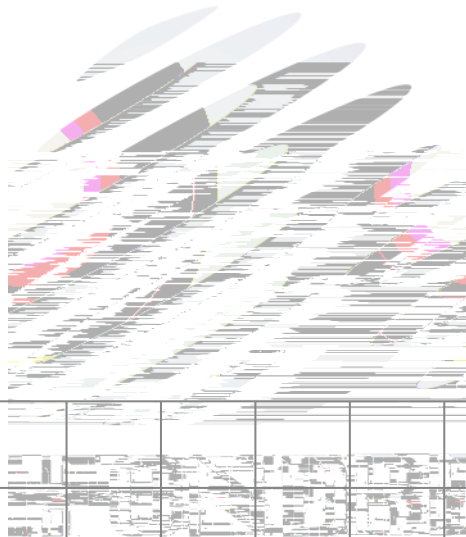


Fig. 1-12 Radiation diagram 辐射特性曲线





2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package: 3000pcs/reel. 包装每卷 。

2.1.1 Carrier Tape Dimension 载带尺寸

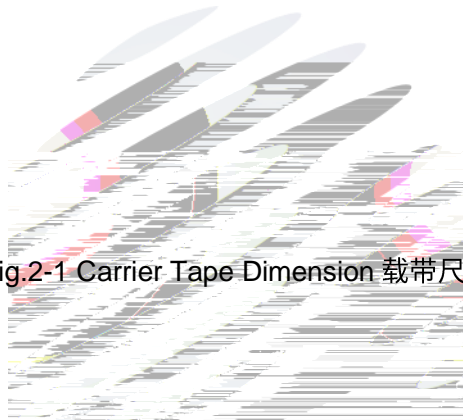


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2 Reel Dimension 卷盘尺寸

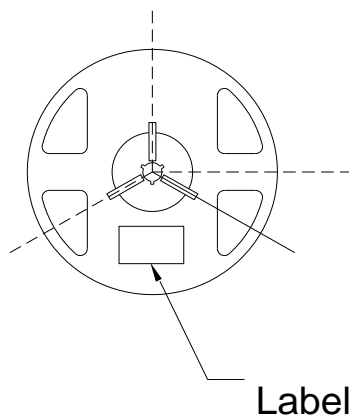


Fig.2-2 Reel Dimension 卷盘尺寸



Table 2-1 Reel Dimension 卷盘尺寸

A	8.0±0.1mm
B	178.0±1.0mm
C	60.0±1.0mm
D	13.0±0.5mm

Notes 备注:

The tolerances unless mentioned ±0.1mm. Unit : mm 注: 未注公差为±0.1毫米, 尺寸单位: 毫米。



2.1.3 Label Form Specification 标签规格

Table 2-2 Specification 规格

PART NO.

Fig. 2-3 Label Form Specification 标签规格

2.2 Moisture Resistant Packing 防潮包装

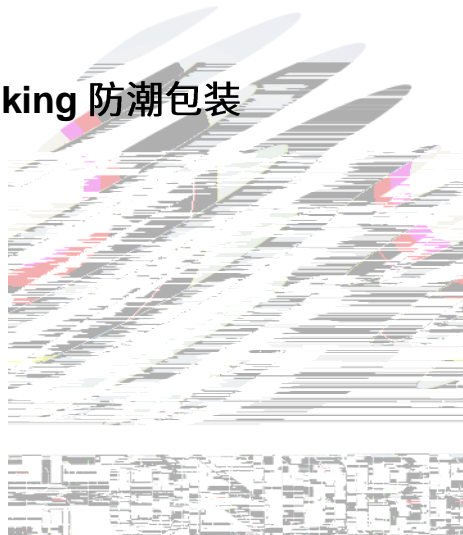


Fig.2-4 Moisture Resistant Packing 防潮包装

2.3 Cardboard Box 包装纸箱

Fig.2-5 Cardboard Box 包装纸箱





3. SMT Reflow Soldering Instructions SMT 回流焊说明

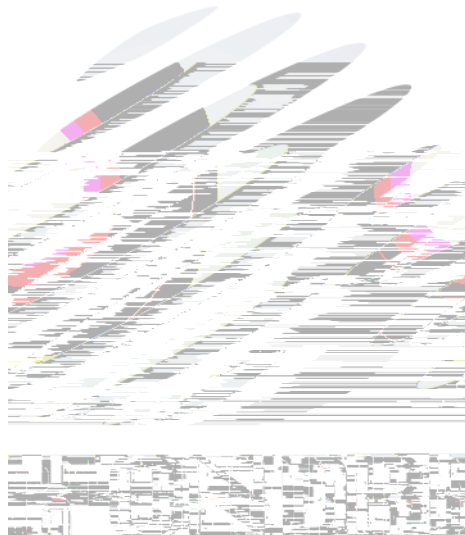
3.1 SMT Reflow Soldering Instructions SMT 回流焊说明

Fig.3-1 SMT Reflow Soldering Instructions SMT 回流焊说明

Table 3-1 Reflow parameters 回流焊参数

Average temperature rise speed 平均升温速度 (T _{smax} 至TP)	最高3 °C/秒 Max 3 °C/ s
Preheating: minimum temperature 预热: 最低温度	

(1)Reflow soldering should not be done more than twice. If more than 24 hours between the two soldering,LED will be damage



4. Handling Precautions 产品使用注意事项

4.1 Handling Precautions 产品使用注意事项

(1) LED operating environment and sulfur element composition cannot be over 100PPM in the LED mating usage material. This is provided for informational purposes only and is not a warranty or endorsement. LED 工作环境及与 LED 适配的材料中硫元素及化合物成份不可超过 100PPM. 这只是一个建议, 不作任何品质担保。

(2) In order to prevent external material from getting into the inside of LED, which may cause the malfunction of LED, the single content of Bromine element is required to be less than 900PPM, the single content of Chlorine element is required to be less than 900PPM, the total content of Bromine element and Chlorine element in the external materials of the application products is required to be less than 1500PPM. This is provided for informational purposes only and is not a warranty or endorsement. 为了防止外界物质进入 LED 内部而造成 LED 的损坏, 外部环境及所用套件等等, 溴元素含量要求小于 900PPM, 单一氯元素含量要求小于 900PPM, 溴元素与氯元素总含量必须小于 1500PPM. 这只是一个建议, 不作任何品质担保。

(3) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues. Refond advises against the use of any chemicals or materials that have been found or are suspected to have an adverse affect on device performance or reliability. To verify compatibility, Refond recommends that all chemicals and materials be tested in the specific application and environment for which they are intended to be used. Attaching LEDs, do not use adhesives that outgas organic vapor. 应用套件中的挥发性物质会渗透到 LED 内部, 在通电产生光子及热的条件下, 会导致 LED 变色, 进而造成严重光衰, 提前了解套件材料能够避免产生这些问题。瑞丰反对使用任何对 LED 器件的性能或者可靠性有害的物质或材料, 不管这些材料是已经证实了的还是仅仅怀疑有害。针对特定的用途和使用环境, 瑞丰建议对所有的物质和材料进行相容性的测试。在贴装 LED 时候, 不要使用能产生有机挥发性气体的粘结剂。

(4) Handle the component along the side surface by using forceps or appropriate tools, Do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry. 通过使用适当的工具从材料侧面夹取, 不可直接用手或尖锐金属物体接触, 它可能损坏内部电路。



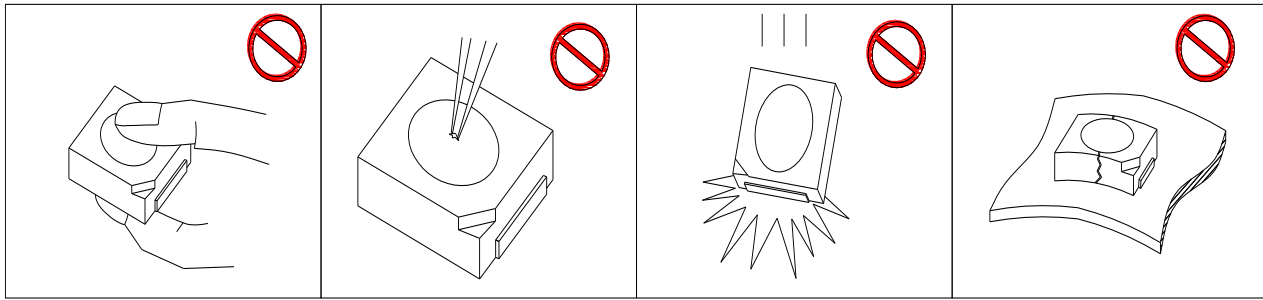


Fig 4-1 Handling Precautions 产品使用注意事项

(5) In designing a circuit, the current through each LED can not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen. The driving circuit must be designed to allow forward voltage only when it is ON or OFF. If the reverse voltage is applied to LED, migration can be generated resulting in LED damage. 设计电路时，通过 LED 的电流不能超过规定的最大值，同时，还需使用保护电阻，否则，微小的电压变化将会引起较大电流变化，可能导致产品损毁。电路设计必须保证只有在开启或者关闭的时候出现正向电压的变化，不要施加反压，否则会损坏 LED。

(6) Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color change and so on. Please consider the heat generation of the LEDs when making the system design. LED 容易因为自身的发热和环境的温度改变而改变，温度升高会降低 LED 发光效率，影响发光颜色，所以在设计时应充分考虑散热问题。

(7) Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust, requiring special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components. Refond suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED. 与其他封装胶相比，硅胶通常较软，表面易吸附脏物，应用时应特别注意。当对产品洁净度要求较高时，回流焊以后需要采用恰当的清洗方式，我们推荐用异丙醇作清洗剂，如需要用到其他清洗剂，必须保证不会破坏封装体。超声清洗可能会对 LED 带来损害，不推荐这种清洗方式。

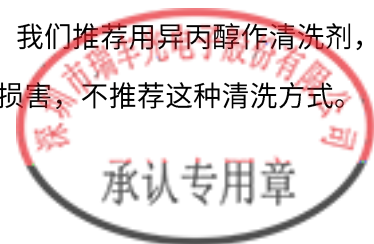


Table 4-1 Storage 储存

Conditions 种类		Temperature	Humidity 湿度	Time 时间
Storage 储存	Before Opening Aluminum Bag 拆包前	30°C	75%	Within 1 Year From Date
	After Opening Aluminum Bag 拆包后	30°C	60%	Recommended for use within 24 hours 建议24小时内使用
Baking 烘烤		60±5°C	-	≥24hours 大于24小时

(8) If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed after unpacking and based on the following condition (60±5)°C for above 24 hours. 如果干燥剂失去包装前, 或者产品不符合以上存放条件, 需拆包后进行烘烤, 烘烤条件: 60±5°C, 大于 24 小时。

If the package is flatulence or damaged, please notify the sales staff to assist. 如果包装胀气或者破损, 请通知销售人员协助处理。

(9) Similar to most Solid state devices; LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). 像其他的半导体电子器件一样, LED 对静电过流击穿非常敏感, 需要做好防护。

(10) Other points for attention, please refer to our relevant information. 其它注意事项请参照瑞丰相关资料。





Declare 申明

This specification is written both in English and in Chinese and the latter is formal.
产品规格书以中英文方式书写，如有冲突以中文版为准